

**AMENDMENTS TO THE SPECIFICATION**

Please insert the following paragraph before the first sentence of the application at page 1, line 1:

--This application claims the benefit of International Application No. PCT/FI2004/000203 filed on April 2, 2004 under 35 U.S.C. §371, entitled, "OXYGEN-FREE COPPER ALLOY AND METHOD FOR ITS MANUFACTURE AND USE OF COPPER ALLOY " which claims the benefit of Finnish Patent Application No. 20030508 filed on April 3, 2003.--

Please replace the paragraph on page 4, between line 12-21 with the following amended paragraph:

--The copper according to the invention can be used in targets where a good temperature resistance is required. These are for instance commutators of electric motors, which contain several segments and the temperature of resins, which are used to fit segments together, will rise up higher than 200°C. Further, the copper alloy of the invention can be used in substrate materials that are coated at high temperatures. For instance, solar panels are manufactured by high-temperature coating processes. One target is also the electrode tips used in welding, ~~preferably~~ preferably in MIG welding, and flat bars and profiles used in generators, in which the copper alloy of the invention replaces the more expensive silver alloy.--